USER MANUAL

Product Name:Bluetooth module

Model:BTM835

Manufacture: Shenzhen Easycore Tecnology Co., Ltd.

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1 Introduction

Easy Core introduces the pioneer of the Bluetooth

4.1 modules BTM835 which is a high performance, cost effective, low power and compact solution. The Bluetooth module provides a complete 2.4GHz Bluetooth system based on the BlueCore CSR8635 chipset which is a single chip radio and baseband IC for Bluetooth 2.4GHz systems,. This module is fully compliant to Bluetooth v4.1 for audio communications.

2 Key Features

Bluetooth Profiles

- Bluetooth v4.1 specification support
- A2DP v1.2
- AVRCP v1.4
- HFP v1.6
- HSP v1.2
- DI v1.3

Music Enhancements

- Configurable 5-band EQ for music playback (rock,pop, classical, jazz, dance etc)
- SBC, MP3, AAC and Faststream decoder
- Volume Boost
- Stereo Widening (S3D)

Additional Functionality

- Support for multi-language programmable audio prompts
- CSR's proximity pairing and CSR's proximity connection
- Multipoint support for A2DP connection to 2 A2DP sources for music playback
- Talk-time extension
- Slim module with 28.5mm x 13mm x 2.0mm

3 Applications

- Stereo Headsets
- Wired Stereo headsets and headphones
- Portable Bluetooth Stereo speakers

4 Block Diagram



5 General specifications

Model Name	BTM835
Product Description	Bluetooth 4.1 Class2 Module
Bluetooth Standard	Bluetooth 4.1
Chipset	CSR8635
Dimension	28.5mm x 13mm x 2.0mm
Operating Conditions	
Voltage	2.8~4.2V
Temperature	-10∼+70℃
Storage Temperature	-40∼+85℃
Electrical Specifications	
Frequency Range	2402~2480MHz
Maximum RF Transmit Power	4dBm
π /4 DQPSK Receive Sensitivity	-91dBm
8DPSK Receive Sensitivity	-81dBm

6 Module Package Information



6.1 Pinout Diagram and package dimensions

Unit: MM

Recommended PCB layout footprint

6.2 Module Pin descriptions



Pin No.	Pin Name	Pin Type	Description
1	PIO6	Bidirectional with strong pull-down	Programmable input/output line 6
2	PIO8	Bidirectional with strong pull-up	Programmable input/output line 8
3	PIO1	Bidirectional with strong pull-up	Programmable input/output line 1
4	PIO0	Bidirectional with strong pull-up	Programmable input/output line 0
5	LED1	Bidirectional	LED driver
6	AIO0	Bidirectional	Analogue programmable input/output line
7	PIO17	Bidirectional with strong pull-down	Programmable input/output line 17
8	PIO9	Bidirectional with strong pull-down	Programmable input/output line 9

9	PIO7	Bidirectional with strong pull-down	Programmable input/output line 7	
10	1V8	1.8V output 1.8V output		
11	PIO16	Bidirectional with strong pull-up	Programmable input/output line 16	
12	PIO14	Bidirectional with strong pull-up	Programmable input/output line 14	
13	PIO15	Bidirectional with strong pull-up	Programmable input/output line 15	
14	PIO21	Bidirectional with weak pull-down	Programmable input/output line 21	
15	PIO18	Bidirectional with weak pull-down	Programmable input/output line 18	
16	SPI_PCM#	Input with weak pull-down	SPI/PCM select input: 0 = PCM/PIO interface 1 = SPI	
17	GND	VSS	Ground	
18	USB_P	Bidirectional	USB data plus	
19	USB_N	Bidirectional	USB data minus	
20	RSTn	Input with strong pull-up	Reset if low. Pull low for minimum 5ms to cause a reset.	
21	SPI_MOSI	Bidirectional with weak pull-down	Programmable input / output line 2 Alternative function: SPI_MOSI: Debug SPI data input	
22	SPI_CLK	Bidirectional with weak pull-down	Programmable input / output line 5 Alternative function: SPI_CLK: Debug SPI clock	
23	SPI_CSB	Bidirectional with weak pull-down	Programmable input / output line 4 Alternative function: SPI_CS#: chip select for Debug	
24	SPI_MISO	Bidirectional with weak pull-down	Programmable input / output line 3 Alternative function: SPI_MISO: Debug SPI data output	
25	VCHG	Charger voltage input	Internal charger input for charging	
26	GND	VSS	Ground	
27	VBAT	Battery positive terminal	Power supply input for 2.8~4.2V	
28	LED0	Bidirectional	LED driver	
29	LED2	Bidirectional	LED driver	
30	VREG_EN	Power on/off key input	Power on/off input key indication	

31	MIC BIAS	Analog	Microphone bias output
32	LINE_BN	Analog input	Line input negative, channel B
33	LINE_BP	Analog input	Line input positive, channel B
34	LINE/MIC_AP	Analog input	Line or microphone input positive, channel
35	LINE/MIC_AN	Analog input	Line or microphone input negative, channe
36	SPK_BN	Analog output	Speaker output negative right
37	SPK_BP	Analog output	Speaker output positive right
38	SPK_AN	Analog output	Speaker output negative left
39	SPK_AP	Analog output	Speaker output positive left
40	GND	VSS	Ground

7 Electrical Characteristics

7.1 Absolute Maximum Ratings

Rating	Minimum	Maximum
Storage temperature	-40 ℃	+85 ℃

7.2 Recommended Operating Conditions

Operating Condition	Minimum	Maximum
Operating temperature range	-10 ℃	+70 ℃
Supply voltage: VBAT	+2.8V	+4.2V

8 Recommended reflow temperature profile





The module Must go through 125 $^\circ\!\!\!\mathbb{C}$ baking for at least 9 hours before SMT AND IR reflow process!

Data	Revision	Description
2013-11-26	V1.0	Original publication of this document.
2016-01-29	V1.4	

Record of Changes

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FCC Statement

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Any Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

The modular can be installed or integrated in mobile or fix devices only. This modular cannot be installed in any portable device.

FCC Radiation Exposure Statement

This modular complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. This modular must be installed and operated with a minimum distance of 20 cm between the radiator and user body.

If the FCC identification number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following: "Contains Transmitter Module FCC ID2AM2VBTM835 Or ContainsFCC ID: 2AM2VBTM835" When the module is installed inside another device, the user manual of the host must contain below warning statements; 1. This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

(1) This device may not cause harmful interference.

(2) This device must accept any interference received, including interference that may cause undesired operation.

2. Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

The devices must be installed and used in strict accordance with the manufacturer's instructions as described in the user documentation that comes with the product.

Any company of the host device which install this modular with limit modular approval should perform the test of radiated emissionand spurious emission according to FCC part 15C : 15.247 and 15.209 requirement, Only if the test result comply with FCC part 15C : 15.247 and 15.209 requirement, then the host can be sold legally.